

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: **Kenichi FUJITA**

Serial Number: **Not Yet Assigned**

Filed: **September 12, 2003**

For: **HEAT RADIATION SHIELDING COMPONENT DISPERSION, PROCESS FOR ITS PREPARATION AND HEAT RADIATION SHIELDING FILM FORMING COATING LIQUID, HEAT RADIATION SHIELDING FILM AND HEAT RADIATION SHIELDING RESIN FORM WHICH ARE OBTAINED USING THE DISPERSION**

**INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

September 12, 2003

Sir:

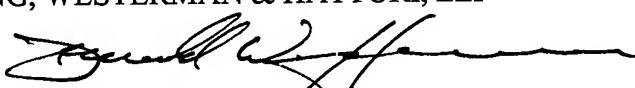
In compliance with 37 CFR 1.56, Applicant calls to the attention of the Patent and Trademark Office the references listed on the attached PTO-1449.

A copy of each of the references are enclosed herewith.

In the event there are any fees due in connection with the filing of this paper, please charge

Deposit Account No. 01-2340.

Respectfully submitted,  
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PATENT TRADEMARK OFFICE

Enclosures: PTO-1449; References (11)

INFORMATION DISCLOSURE STATEMENT PTO-1449	Atty. Docket No. 031043	Serial No. New Application
	Applicant(s): Kenichi FUJITA	
	Filing Date: September 12, 2003	Group Art Unit: Not Yet Assigned

#### U.S. PATENT DOCUMENTS

Examiner Initial	Document No.	Name	Date	Class	Subclass	Filing Date (If appropriate)
_____	AA AB					

#### FOREIGN PATENT DOCUMENTS

	Document No.	Date	Country	Translation (Yes or No)
_____	AC	2001-179887	07/03/01	Japan Yes-Abstract/Discussed in the specification
_____	AD	2000-169765	06/20/00	Japan Yes-Abstract/Discussed in the specification
_____	AE	2000-96034	04/04/00	Japan Yes-Abstract/Discussed in the specification
_____	AF	11-181336	07/06/99	Japan Yes-Abstract/Discussed in the specification
_____	AG	10-146919	06/02/98	Japan Yes-Abstract/Discussed in the specification
_____	AH	7-69632	03/14/95	Japan Yes-Abstract
_____	AI	6-264050	09/20/94	Japan Yes-Abstract/Discussed in the specification
_____	AJ	6-256541	09/13/94	Japan Yes-Abstract/Discussed in the specification
_____	AK	5-78544	03/30/93	Japan Yes-Abstract/Discussed in the specification
_____	AL	2-173060	07/04/90	Japan Yes-Abstract/Discussed in the specification
_____	AM	61-277437	12/08/86	Japan No/Discussed in the specification

#### OTHER DOCUMENTS

_____	AJ AK	
Examiner		Date Considered